

RESPONSE UNDER 37 CFR 1.116  
EXPEDITED PROCEDURE  
EXAMINING GROUP 2811

PATENT APPLICATION  
Docket No.: 9903-068  
Client Ref. No.: S03US008

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Dae-Woo SON, et al.

Serial No.: 10/739,456 Examiner: Owens, Douglas W.

Filed: December 17, 2003 Group Art Unit: 2811

Confirmation No.: 9321

For: TAPE CIRCUIT SUBSTRATE HAVING WAVY BEAM LEADS AND  
SEMICONDUCTOR CHIP PACKAGE USING THE SAME

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT AFTER FINAL REJECTION UNDER 37 CFR 1.116**

Responsive to the Final Office Action, Paper No. 20060310, dated March 16, 2006,  
please amend the application as follows.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3  
of this paper.

**Remarks/Arguments** begin on page 9 of this paper.

*Do not enter  
DhJ*